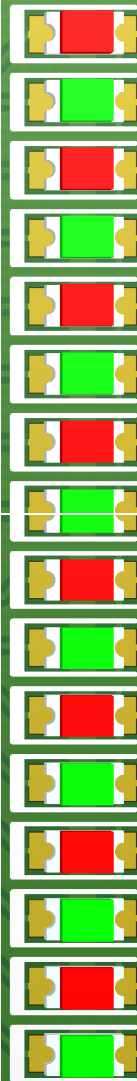




TEXAS  
INSTRUMENTS

TIDA-00560E1

- D16
- D15
- D14
- D13
- D12
- D11
- D10
- D9
- D8
- D7
- D6
- D5
- D4
- D3
- D2
- D1

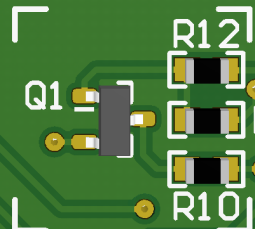


FAULT SIMULATION

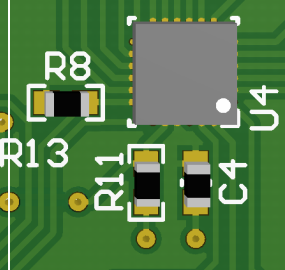
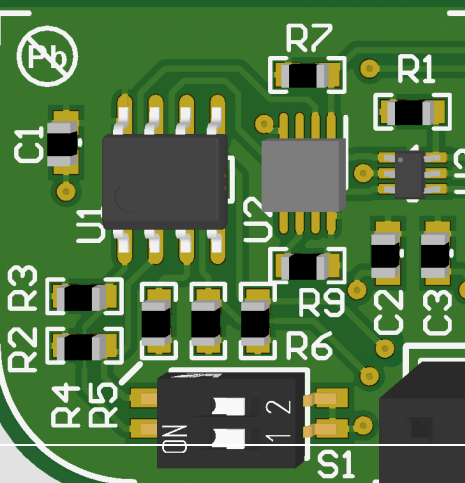


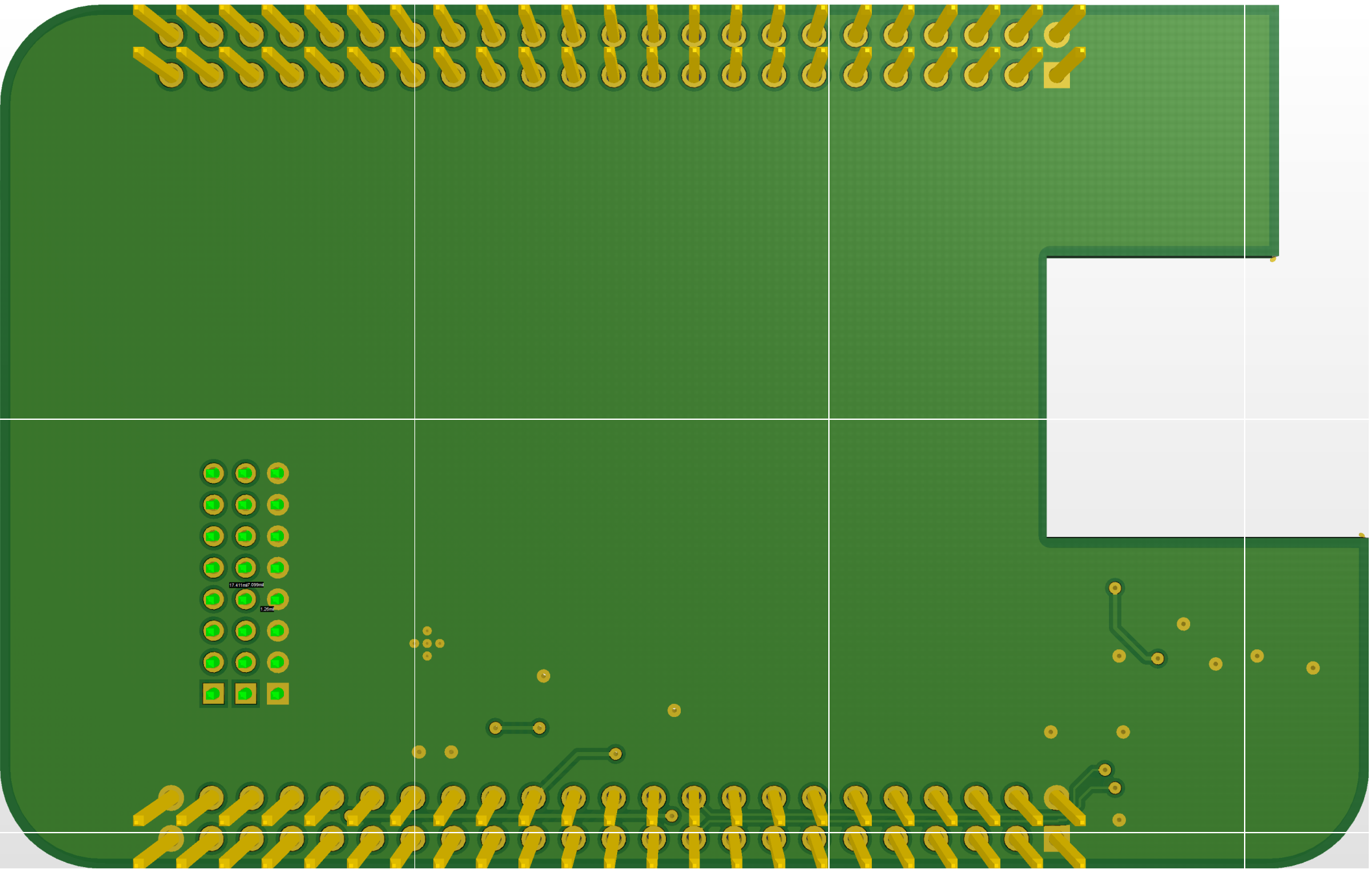
J1C  
J1B  
J1A

BRIGHTNESS  
(OPTIONAL)



CAPE-ID AND  
ADDR-DEC





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